

IRFI9Z14GPBF-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)	Q_g (Typ)
- 60	0.100 at $V_{GS} = -10$ V	- 20	12.5
	0.120 at $V_{GS} = -4.5$ V	- 15	

FEATURES

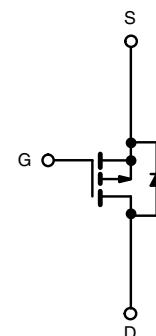
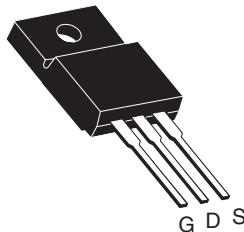
- TrenchFET® Power MOSFET
- 100 % UIS Tested

APPLICATIONS

- Load Switch



TO-220 FULLPAK



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

Parameter	Symbol	Limit	Unit
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ($T_J = 175$ °C)	I_D	- 20	A
$T_C = 25$ °C	I_D	- 12	
Pulsed Drain Current	I_{DM}	- 60	
Continuing Source Current (Diode Conduction)	I_S	- 12	
Avalanche Current	I_{AS}	- 12	
Single Pulse Avalanche Energy	E_{AS}	7.2	mJ
Maximum Power Dissipation	P_D	30 ^a	W
$T_C = 25$ °C	P_D	2 ^b	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient ^b	R_{thJA}	20	25	°C/W
Steady State	R_{thJA}	62	75	
Junction-to-Case	R_{thJC}	5	6	

Notes:

- See SOA curve for voltage derating.
- Surface Mounted on 1" x 1" FR-4 board.

SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250 \mu\text{A}$	- 1.0	- 2.0	- 3.0	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -60 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			- 1	μA
		$V_{\text{DS}} = -60 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 125^\circ\text{C}$			- 50	
		$V_{\text{DS}} = -60 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 175^\circ\text{C}$			- 150	
On-State Drain Current ^b	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} = -5 \text{ V}, V_{\text{GS}} = -10 \text{ V}$	- 10			A
Drain-Source On-State Resistance ^b	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10 \text{ V}, I_D = -5 \text{ A}$		0.100		Ω
		$V_{\text{GS}} = -10 \text{ V}, I_D = -5 \text{ A}, T_J = 125^\circ\text{C}$		0.150		
		$V_{\text{GS}} = -10 \text{ V}, I_D = -5 \text{ A}, T_J = 175^\circ\text{C}$		0.200		
		$V_{\text{GS}} = -4.5 \text{ V}, I_D = -2 \text{ A}$		0.120		
Forward Transconductance ^b	g_{fs}	$V_{\text{DS}} = -15 \text{ V}, I_D = -5 \text{ A}$		8		S
Dynamic						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1 \text{ MHz}$		550		pF
Output Capacitance	C_{oss}			95		
Reverse Transfer Capacitance	C_{rss}			60		
Total Gate Charge	Q_g	$V_{\text{DS}} = -30 \text{ V}, V_{\text{GS}} = -10 \text{ V}, I_D = -8.4 \text{ A}$		12.5	19	nC
Gate-Source Charge	Q_{gs}			2.3		
Gate-Drain Charge	Q_{gd}			3.2		
Gate Resistance	R_g		$f = 1 \text{ MHz}$	8.0		Ω
Turn-On Delay Time ^c	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -30 \text{ V}, R_L = 3.57 \Omega$ $I_D \approx -8.4 \text{ A}, V_{\text{GEN}} = -10 \text{ V}, R_G = 2.5 \Omega$		5	10	ns
Rise Time ^c	t_r			14	25	
Turn-Off Delay Time ^c	$t_{\text{d}(\text{off})}$			15	25	
Fall Time ^c	t_f			7	12	
Source-Drain Diode Ratings and Characteristics ($T_C = 25^\circ\text{C}$) ^b						
Pulsed Current	I_{SM}				- 20	A
Forward Voltage ^b	V_{SD}	$I_F = -2 \text{ A}, V_{\text{GS}} = 0 \text{ V}$		- 0.9	- 1.3	V
Reverse Recovery Time	t_{rr}	$I_F = -8 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}$		50	80	ns
Reverse Recovery Time	Q_{rr}			80	120	nC

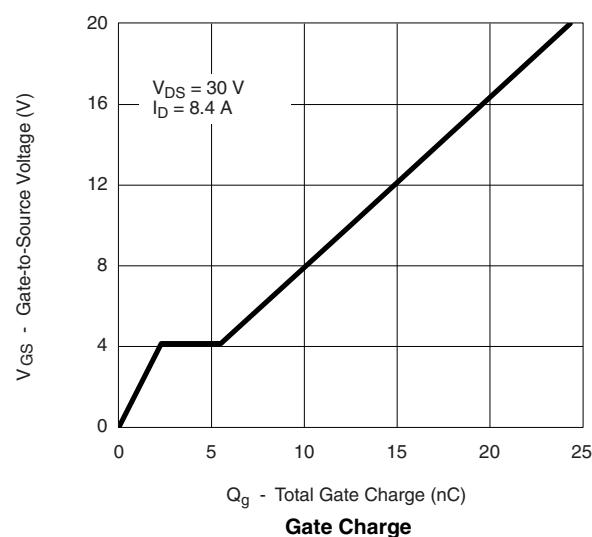
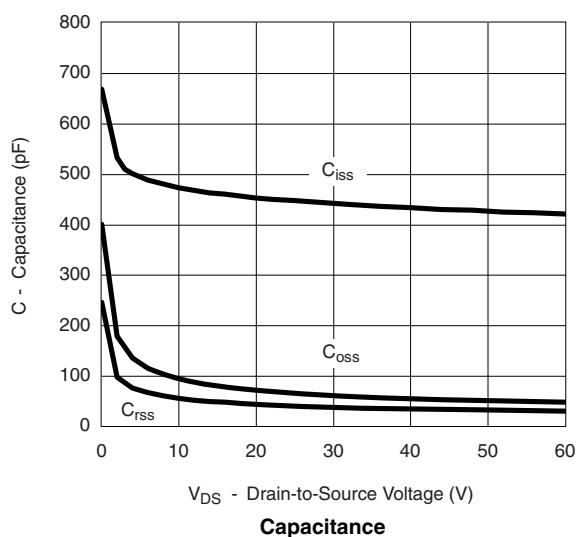
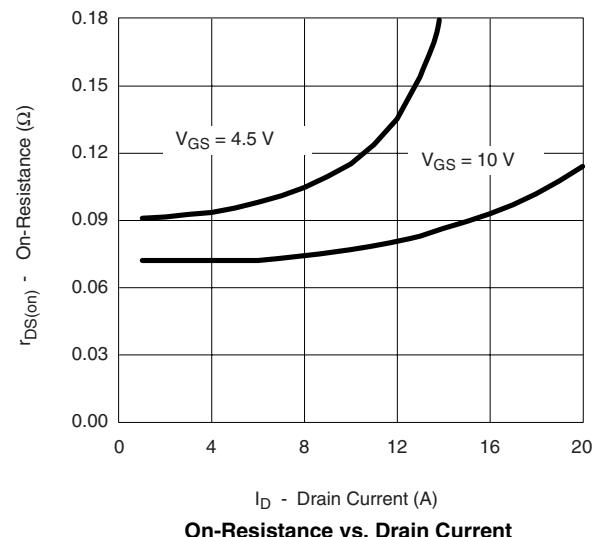
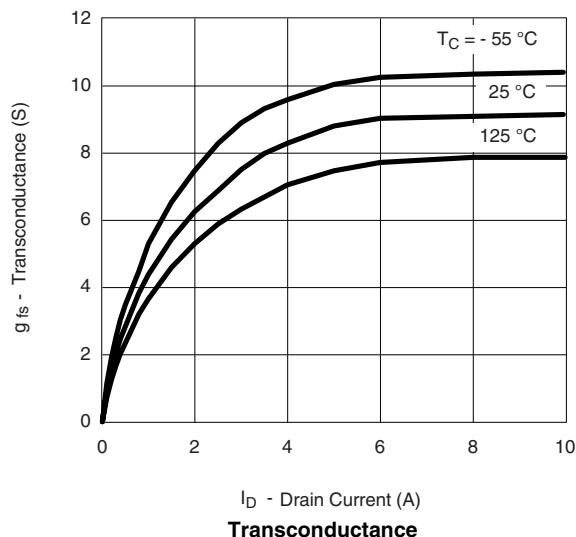
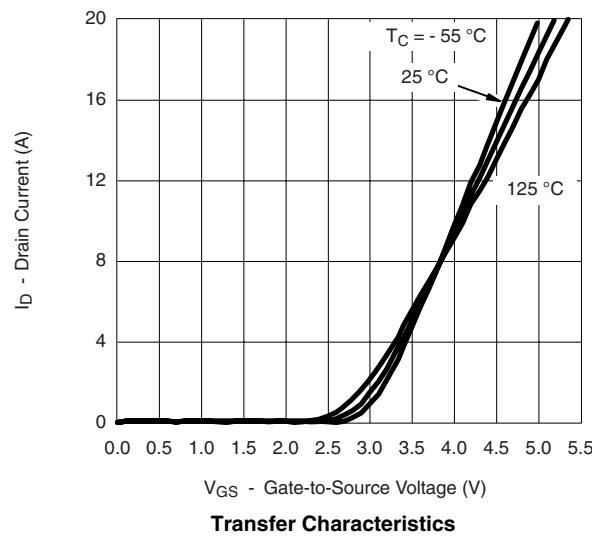
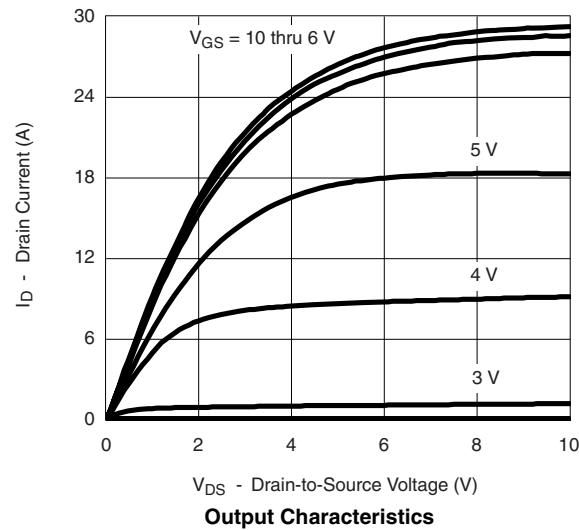
Notes:

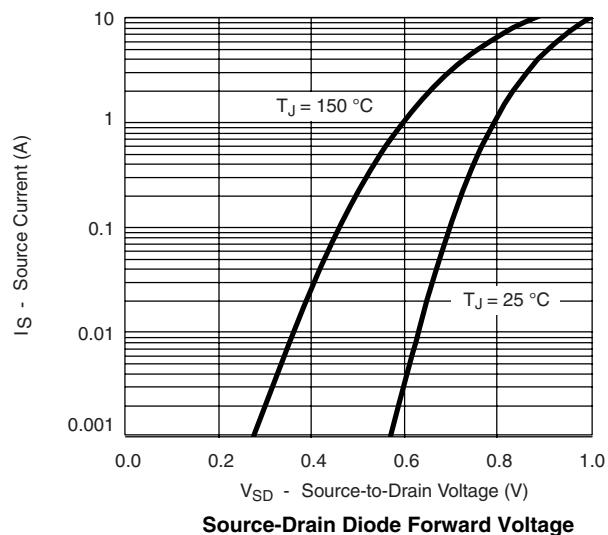
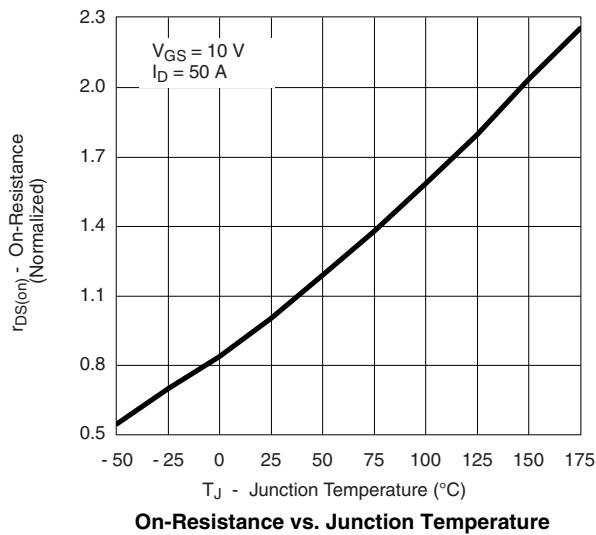
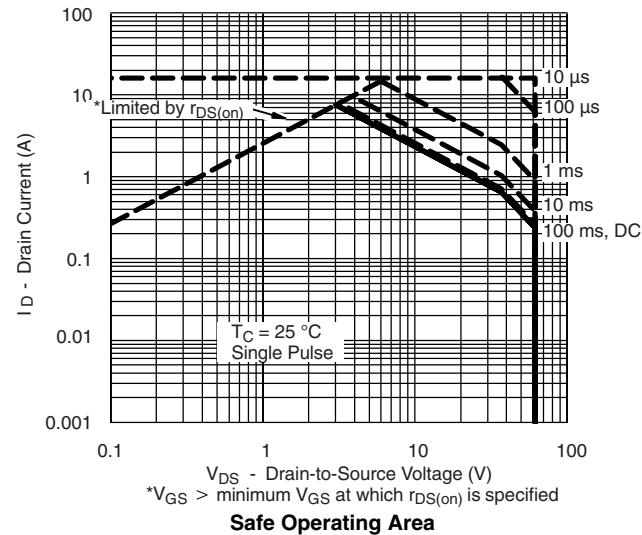
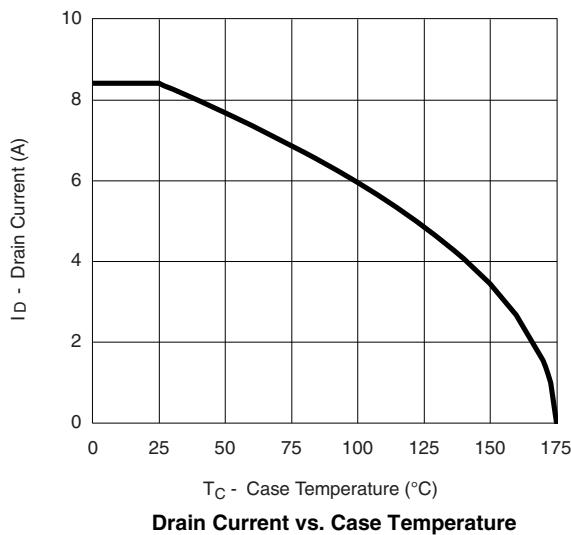
a. Guaranteed by design, not subject to production testing.

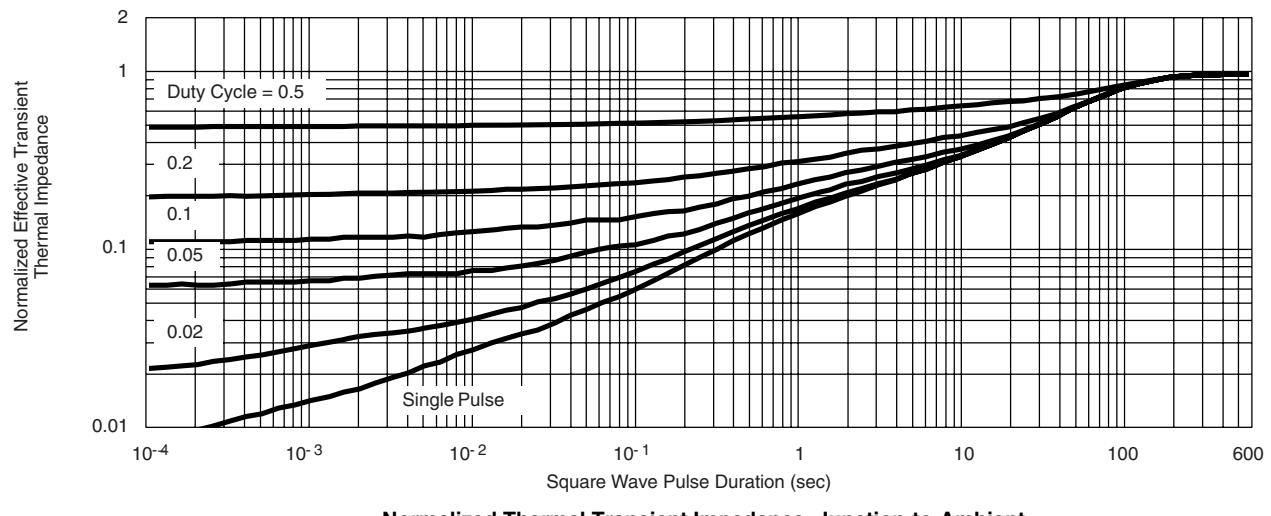
b. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

c. Independent of operating temperature.

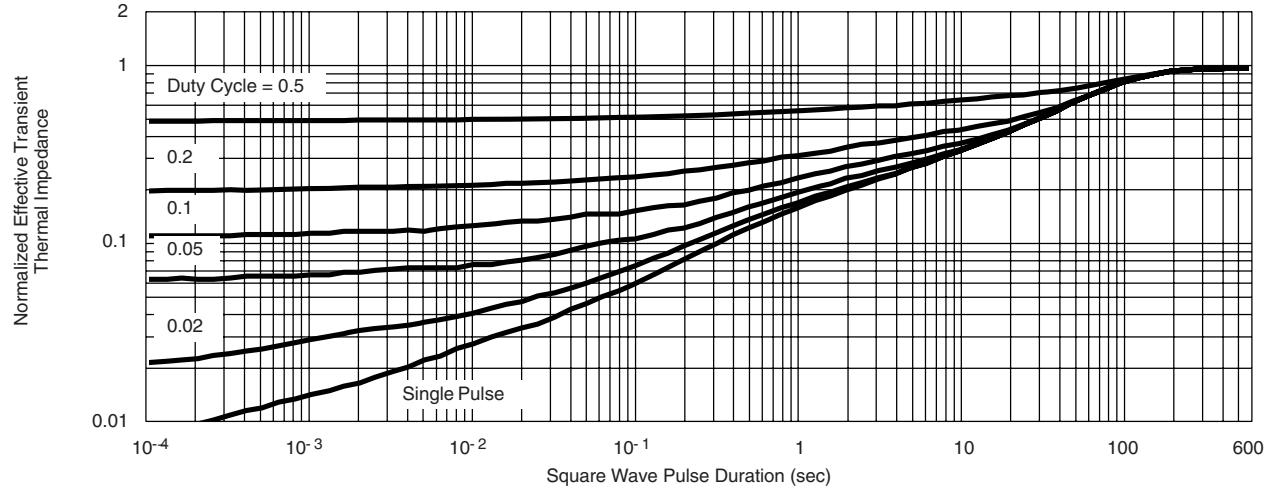
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted


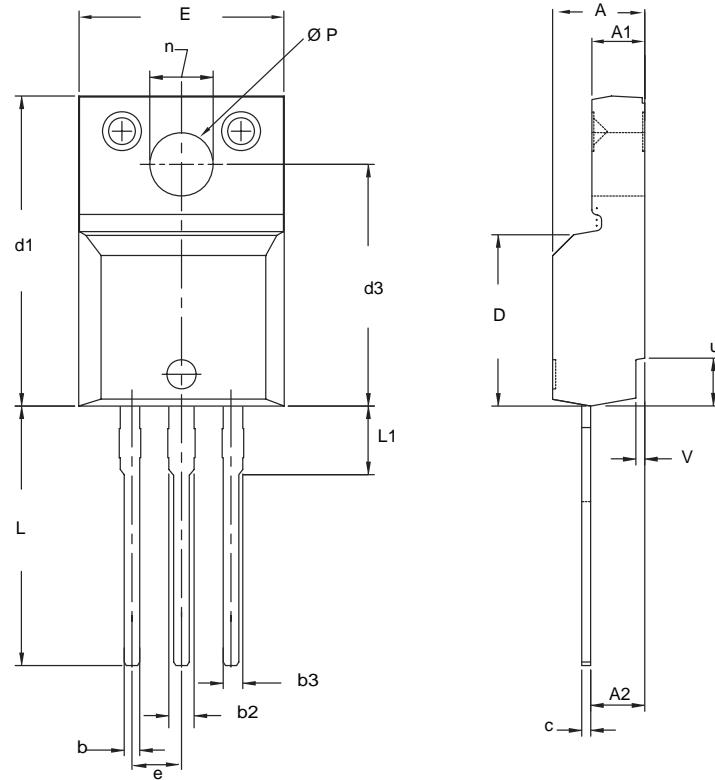
TYPICAL CHARACTERISTICS 25 °C unless noted

THERMAL RATINGS


THERMAL RATINGS

Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

TO-220 FULLPAK

DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
c	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
e	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
Ø P	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
v	0.400	0.500	0.016	0.020

ECN: X09-0126-Rev. B, 26-Oct-09
 DWG: 5972

Notes

1. To be used only for process drawing.
2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
3. All critical dimensions should C meet $C_{pk} > 1.33$.
4. All dimensions include burrs and plating thickness.
5. No chipping or package damage.

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